

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number:

0753416676

Status:

Active

Overview:

gbx_backplane_connector_system

Description:

1.85mm by 1.85mm (.073 by .073") Pitch 4-Pair GbX® Backplane Connector System, Power Module, 12 Circuits, 1.27µm (50µ") Gold (Au)

Documents:

Drawing (PDF)

Product Specification PS-75221-999 (PDF)

RoHS Certificate of Compliance (PDF)

Agency Certification

UL

E29179

General

Product Family

Series

Application

Application Tooling Documents

Comments

Component Type

Overview

Product Name

Style

Backplane Connectors

75341

Backplane

Tooling Manual

Blade Length A 6.00mm, B 6.00mm, C 7.50mm, D 6.00mm

Power Header

gbx_backplane_connector_system

GbX®

N/A

Physical

Circuits (Loaded)

Circuits (maximum)

Circuits Detail

Color - Resin

Durability (mating cycles max)

First Mate / Last Break

Flammability

Guide to Mating Part

Keying to Mating Part

Material - Plating Mating

Material - Plating Termination

Material - Resin

Number of Columns

Number of Pairs

Number of Rows

Orientation

PC Tail Length (in)

PC Tail Length (mm)

PCB Locator

PCB Retention

PCB Thickness Recommended (in)

PCB Thickness Recommended (mm)

Packaging Type

Pitch - Mating Interface (in)

Pitch - Mating Interface (mm)

Pitch - Term. Interface (in)

Pitch - Term. Interface (mm)

Plating min: Mating (µin)

Plating min: Mating (µm)

8

8

Rows A, B, C, & D

Gray

200

Yes

94V-0

No

None

Gold

Tin-Lead

High Temperature Thermoplastic

N/A

4

4

Vertical

0.089 In

2.28 mm

Yes

Yes

0.063 In

1.60 mm

Tube

0.073 In

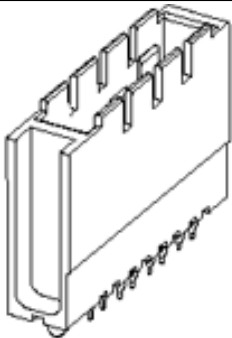
1.85 mm

0.102 In

2.60 mm

50

1.25



Series

image - Reference only

EU RoHS

RoHS Compliant by Exemption

REACH SVHC

Contains SVHC: No

Halogen-Free

Status

Halogen-Free

China RoHS

50

Pb

Need more information on product environmental compliance?

Email productcompliance@molex.com

For a multiple part number RoHS Certificate of Compliance, [click here](#)

Please visit the [Contact Us](#) section for any non-product compliance questions.

Search Parts in this Series

75341Series

Mates With

75292 GbX® Daughtercard

Application Tooling | FAQ

Tooling specifications and manuals are found by selecting the products below. Crimp Height Specifications are then contained in the Application Tooling Specification document.

Global

Description	Product #
Insertion Module, GbX® 4 pair 1- Up Power Module	0622022005
GbX® Single Pin Repair Tool	0622022090
GbX® Shield Removal Tool	0622022100

Plating min: Termination (μin)	30
Plating min: Termination (μm)	0.75
Polarized to PCB	Yes
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55°C to +105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	6A
Data Rate	8.0 Gbps
Real Signals (per 25mm)	0
Shielded	No
Voltage - Maximum	120V AC (RMS)/DC

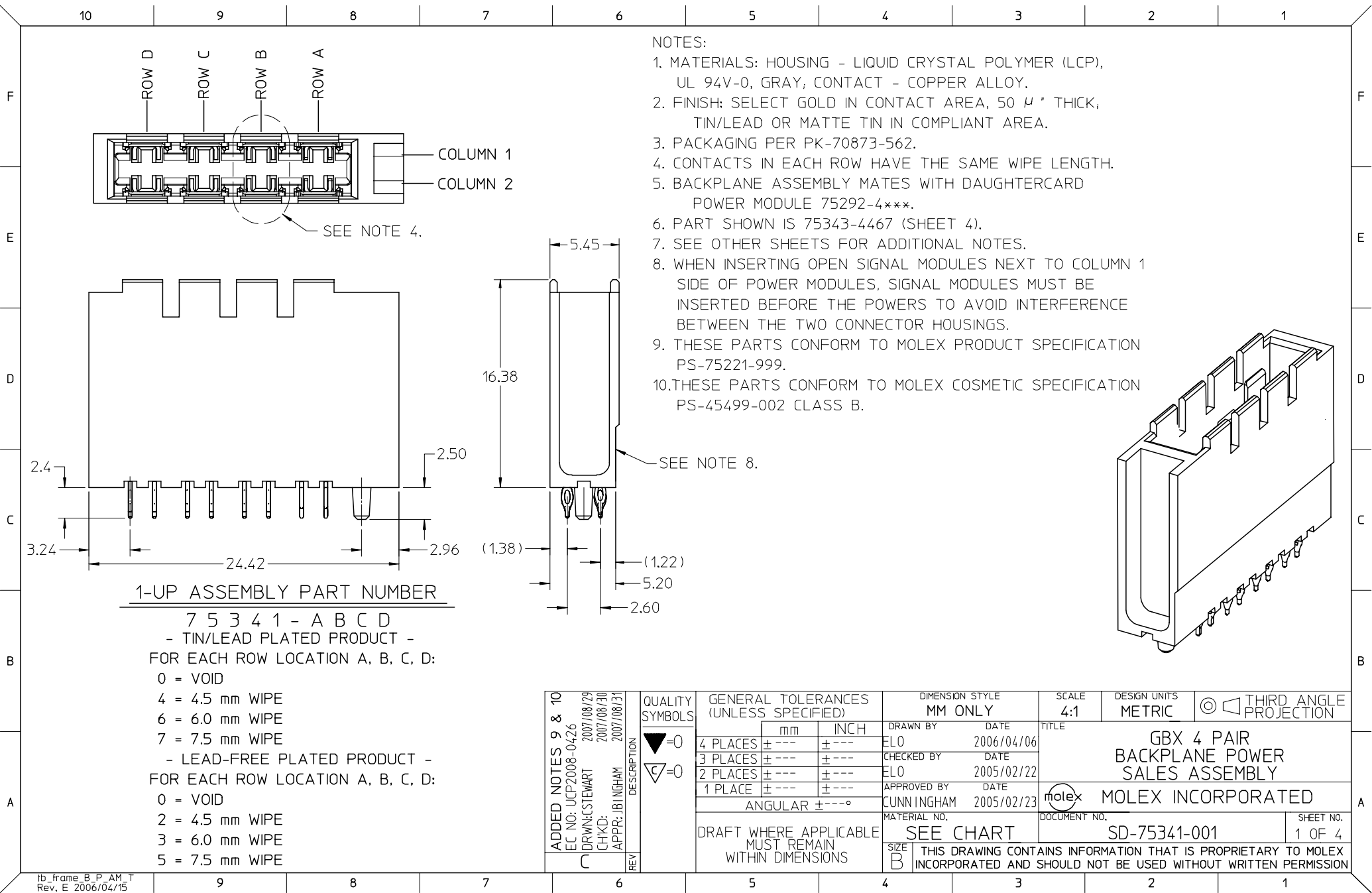
Material Info

Reference - Drawing Numbers

Product Specification	PS-75221-999
Sales Drawing	SD-75341-001

GbX is a registered trademark of Amphenol Corporation.

This document was generated on 05/13/2010
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ADDED NOTES 9 & 10 EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: 2007/08/30 APPR: J. B. INGHAM 2007/08/31				QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
								DRAWN BY ELO		DATE 2006/04/06	TITLE GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX INCORPORATED SD-75341-001			
						4 PLACES ± --- ± ---		CHECKED BY ELO		DATE 2005/02/22				
						3 PLACES ± --- ± ---		APPROVED BY CUNNINGHAM		DATE 2005/02/23				
						2 PLACES ± --- ± ---		MATERIAL NO. SEE CHART		DOCUMENT NO. SD-75341-001			SHEET NO. 1 OF 4	
						1 PLACE ± --- ± ---		SIZE B		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				
ANGULAR ± --- °		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS												

10 9 8 7 6 5 4 3 2 1



2-UP ASSEMBLY PART NUMBER

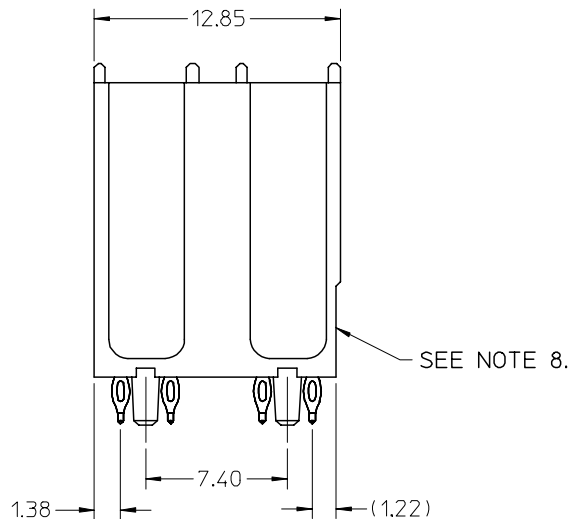
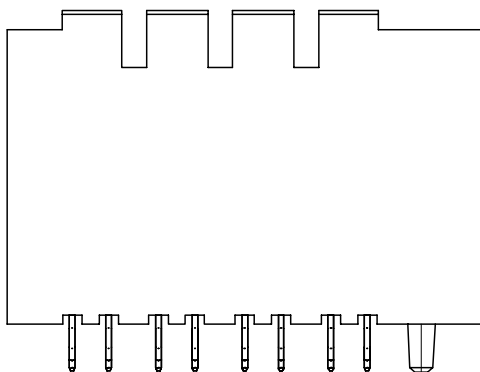
7 5 3 4 2 - A B C D

- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C, D:

0 = VOID
4 = 4.5 mm WIPE
6 = 6.0 mm WIPE
7 = 7.5 mm WIPE

- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B, C, D:

0 = VOID
2 = 4.5 mm WIPE
3 = 6.0 mm WIPE
5 = 7.5 mm WIPE



SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

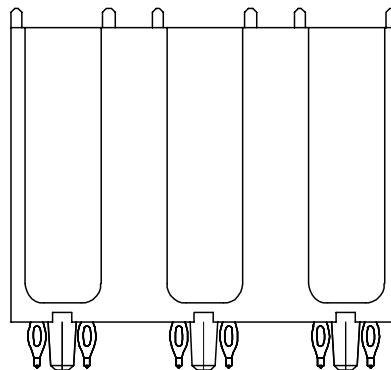
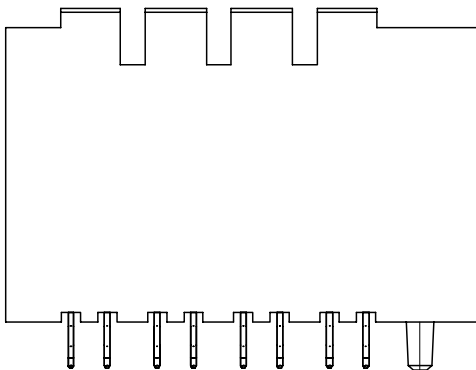
SEE SHEET ONE EC NO: UCP2008-0426 DRAWN: C STEWART 2007/08/29 CHKD: 2007/08/30 APPR: J BINGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
				mm	INCH	DRAWN BY ELO	DATE 2006/04/06	GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY			
			4 PLACES	± ---	± ---	CHECKED BY	DATE				
			3 PLACES	± ---	± ---	ELO	2005/02/22	MOLEX INCORPORATED			
			2 PLACES	± ---	± ---	APPROVED BY	DATE				
			1 PLACE	± ---	± ---	CUNNINGHAM	2005/02/23				
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			ANGULAR ± ---°		MATERIAL NO.		DOCUMENT NO.		SHEET NO.		
									2 OF 4		
REV					SIZE B	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					

9 8 7 6 5 4 3 2 1



COLUMN 1
COLUMN 2
COLUMN 3
COLUMN 4
COLUMN 5
COLUMN 6

SEE NOTE 4.



SEE NOTE 8.

3-UP ASSEMBLY PART NUMBER

7 5 3 4 3 - A B C D

- TIN/LEAD PLATED PRODUCT -

FOR EACH ROW LOCATION A, B, C, D:

0 = VOID

4 = 4.5 mm WIPE

6 = 6.0 mm WIPE

7 = 7.5 mm WIPE

- LEAD-FREE PLATED PRODUCT -

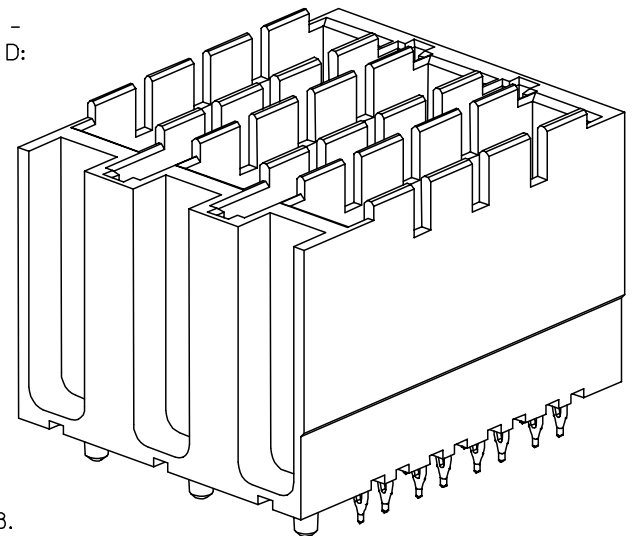
FOR EACH ROW LOCATION A, B, C, D:

0 = VOID

2 = 4.5 mm WIPE

3 = 6.0 mm WIPE

5 = 7.5 mm WIPE



SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-0426 DRW: J. STEWART 2007/08/29 CHKD: J. STEWART 2007/08/30 APPR: J. INGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION		
				mm	INCH	DRAWN BY ELO	DATE 2006/04/06	TITLE GBX 4 PAIR BACKPLANE POWER SALES ASSEMBLY			
			4 PLACES	± ---	± ---	CHECKED BY	DATE				
			3 PLACES	± ---	± ---	ELO	2005/02/22				
			2 PLACES	± ---	± ---	APPROVED BY	DATE				
			1 PLACE	± ---	± ---	CUNNINGHAM	2005/02/23	 MOLEX INCORPORATED			
			ANGULAR ± ---°		MATERIAL NO.	DOCUMENT NO.	SHEET NO. 3 OF 4				
			DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SEE CHART						
			REV C			SIZE B	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION				

10 9 8 7 6 5 4 3 2 1

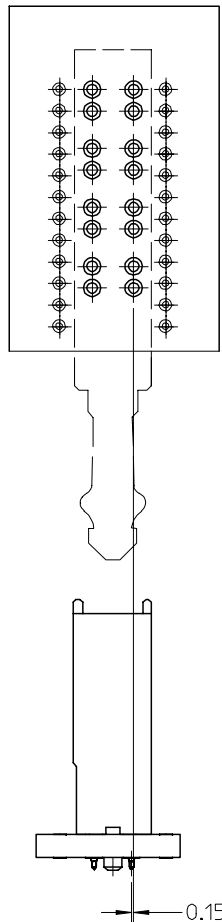
F
E
D
C
B
A

SEE NOTE 5.

6.0 mm WIPE
7.5 mm WIPE

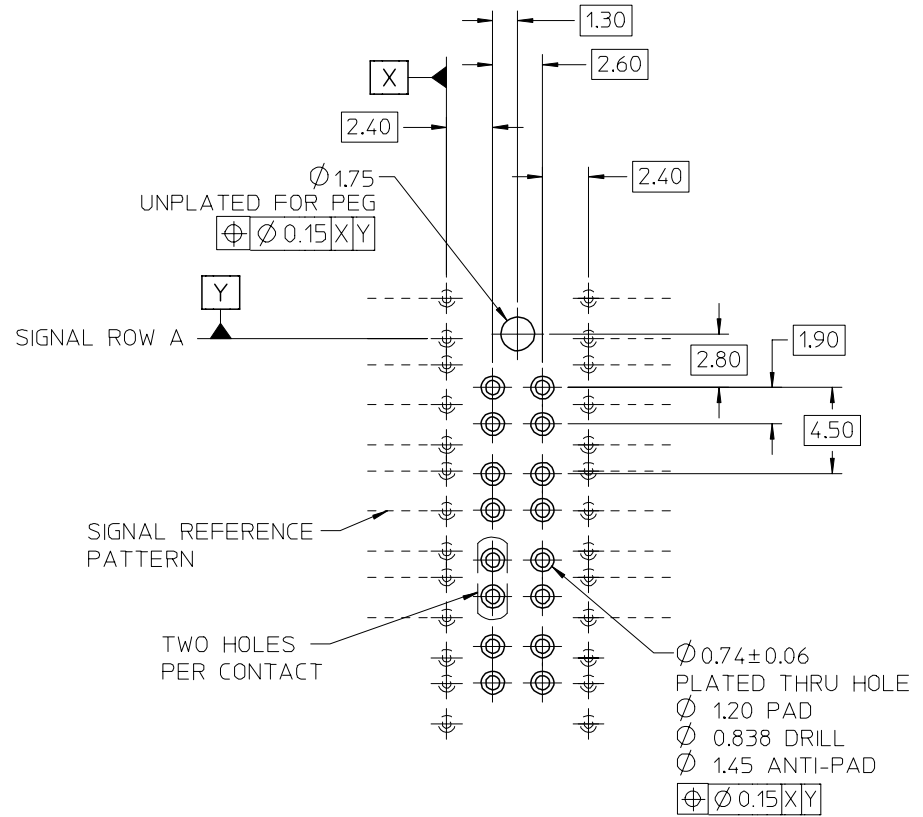
4.5 mm WIPE

0.76
DC BOARD EDGE TO
CENTERLINE OF BP TAIL



HOLE PATTERN FOR 1-UP ASSEMBLY

- 1.) ADD 7.40 FROM CENTERLINES OF PEGS FOR MULTIPLE UP ASSEMBLIES.
- 2.) ADD 5.55 FROM CENTERLINE TO CENTERLINE OF PEG FOR INDIVIDUAL POWER MODULES STACKED NEXT TO EACH OTHER.



ADDED $\phi 0.74 \pm 0.06$ EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: 2007/08/30 APPR: J. BINGHAM 2007/08/31	QUALITY SYMBOLS $\nabla=0$ $\nabla=0$	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
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		4 PLACES	$\pm$ ---	$\pm$ ---		CHECKED BY ELO	DATE 2005/02/22		
		3 PLACES	$\pm$ ---	$\pm$ ---		APPROVED BY CUNNINGHAM	DATE 2005/02/23	MOLEX INCORPORATED	
REV C	DESCRIPTION	2 PLACES	$\pm$ ---	$\pm$ ---		MATERIAL NO.	DOCUMENT NO.		
		1 PLACE	$\pm$ ---	$\pm$ ---		SEE PREVIOUS		SD-75341-001	
		ANGULAR $\pm$ ----							
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS						SHEET NO. 4 OF 4	

9 8 7 6 5 4 3 2 1

Данный компонент на территории Российской Федерации

Вы можете приобрести в компании MosChip.

Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

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